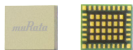


Wi-Fi®/Bluetooth® Modules for NXP i.MX

Wi-Fi® modules

Type ZX



PN: LBWA17DZX6

BCM43362 Chipset

Footprint: 7.0 x 6.0 x 1.2mm



Type 1FX



PN: LBWA1KL1FX

BCM43364 Chipset

Footprint: 6.95 x 5.15 x 1.1mm



Available through distribution
(Arrow, Avnet, Digi-Key, Mouser)

SN8000



PN: 88-00153-00

BCM43362 Chipset

Footprint: 24.0 x 11.4 x 2.0 mm

FCC/IC Certified



Wi-Fi® + Bluetooth® modules

Type 1BW



PN: LBEH5DU1BW

BCM43340 Chipset

Footprint: 8.0 x 7.5 x 1.13mm



Type ZP



PN: LBEH5HMZPC

BCM4339 Chipset

Footprint: 7.8 x 7.4 x 1.0mm



Type 1DX



PN: LBEE5KL1DX

BCM4343W Chipset

Footprint: 6.95 x 5.15 x 1.1mm

FCC/IC Reference Certified



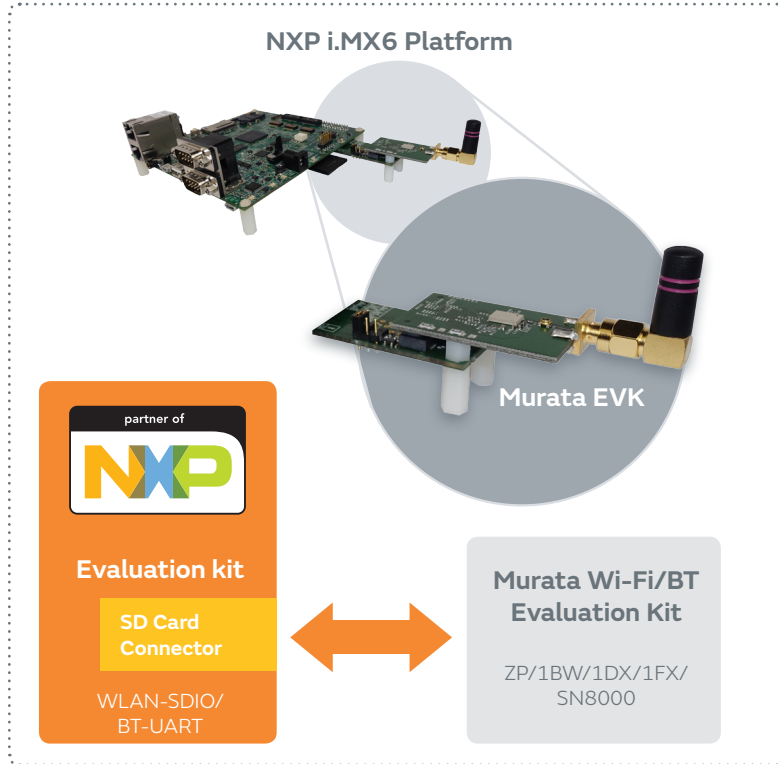
Learn more online

wireless.murata.com/imx
imxfqa@murata.com



Wi-Fi®/Bluetooth® Modules for NXP i.MX

Platform



Software

- NXP Linux and Android i.MX 6 BSP's have native/integrated support for all Murata Modules based on Broadcom Chipsets.
- Linux 3.14.x and Android Lollipop 5.1.x releases available from NXP website.



Mouser Electronics

Authorized Distributor

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Murata:

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